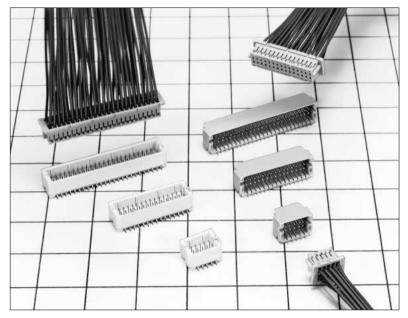
# 1 mm Pitch Double Rows Low Profile Board-to-Cable Connectors

DF20 series



#### Features

#### **1. Contact Pitch**

1 mm contact pitch allows reliable solder and cable termination.

#### 2. Low profile

Total mating height above the board is 5.8 mm for the straight type and 5.5 mm for the right angle type.

#### 3. Reliable electrical connection wipe

Effective electrical connection is assured with a 1mm wipe of mating contacts.

#### 4. Narrower external width and length

Redesigned metal fittings decreased the overall length of the board- mount receptacle and permit end-to-end mounting of several connectors.

#### 5. Automatic equipment board placement

Straight type pin headers are supplied with a 5.4 mm X 4.6mm flat platform to allow vacuum pick-up and placement on the board.

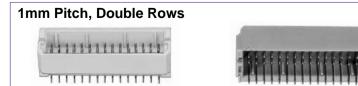
#### 6. Product variations

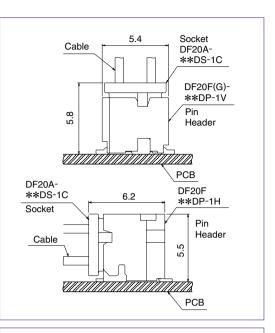
- (1) Available with 10, 20, 30, 40, and 50 contacts.
- (2) Pin headers are available in two types: with or without board positioning bosses.
- (3) Depending on specific application pin headers can be ordered in straight or right angle types.

## Applications

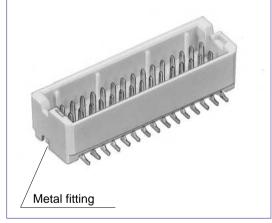
Notebook PC, small office automation equipment, small consumer devices, portable devices.

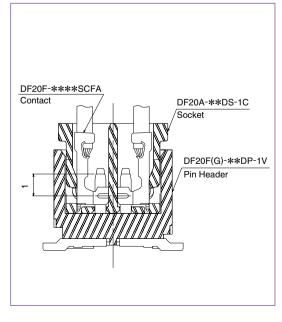
Any application requiring low profile reliable board-to-cable connection with a AWG #28, AWG#30, AWG#32 conductors.





#### Narrower external width and length





# Product Specifications

	Rated current	AWG#28 : 1A AWG#30 : 0.9A	Operating temperature range	-35°C to 85°C (Note 1,2)	Storage temperature range	-10°C to 60°C (Note 2)
Rating	Rated voltage	AWG#32 : 0.7A 100V AC	Operating humidity range	20% to 80%	Storage humidity range	40% to 70%

Item	Specifications	Conditions
1.Insulation resistance	500MΩ min.	Measured at 100V DC
2.Withstanding voltage	No flashover or insulation breakdown	Conduction of 300V AC applied for 1 minute
3.Contact resistance	30MΩ max.	Measure at 100mA.
4.Insertion-Extraction force (per contact)	Min. 0.2 N (20 gf), Max. 2 N (200 gf)	Measured with a steel pin of 0.2 $\pm$ 0.005 thickness
5.Vibration	No electrical discontinuity of 1µs min.	Frequency of 10 to 55 Hz, single amplitude of 0.75 mm, in 3 directions for 2hours
6.Humidity	Contact resistance of 30m $\Omega$ max., insulation resistance of 100M $\Omega$ min.	Temperature of $40\pm 2^{\circ}$ C, humidity of 90% to 95%, left standing for 96 hours
7.Temperature cycle	Contact resistance of 30m $\Omega$ max, insulation resistance of 500M $\Omega$ min.	(-55°C:30min → 5°C to 35°C: 2 to 3min → 85°C:30min → 5°C to 35°C:2 to 3min ) for 5 cycles
8.Mechanical operation	Contact resistance of 30mΩ max.	50 cycles
9.Resistance to Soldering heat	No deformation of the insulator parts that will affect performance	Reflow: At the recommended temperature profile, manual solder: Soldering iron temperature of 300°C for 3 seconds

Note1: Includes temperature rise caused by current flow.

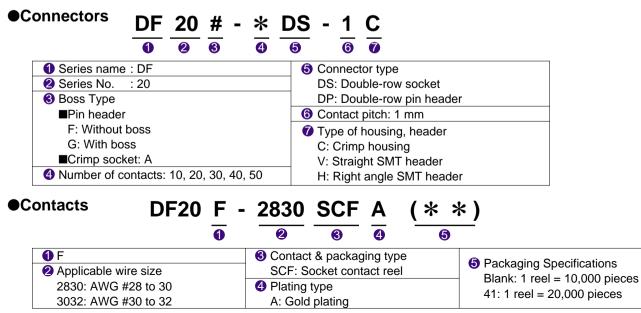
Note2: The term "storage" refers to products stored for long periods of time prior to mounting and use.

Operating temperature range and Humidity range covers non-conducting conditions of installed connectors in storage, shipment or transportation.

#### Materials

Item	Part	Material	Finish	Remarks
Socket	Insulator	Insulator Polyamide		UL94V-0
Socket contact	Contact	Phosphor bronze	Gold plating	
	Insulator	Polyamide	Color : Beige	UL94V-0
	Contact	Phosphor bronze	Gold plating	
Pin header	Metal Fitting	Brass	ass V type: Solder plating H type: Tin-Copper plating (P	

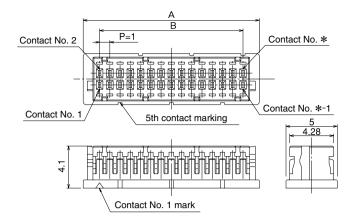
## Ordering Information





# Double Row Socket





Shown with terminated and installed contacts

_					Unit: mm
	Product No.	CL No.	Number of Contacts	А	В
	DF20A-10DS-1C	686-0020-3	10	7.2	4.0
	DF20A-20DS-1C	686-0021-6	20	12.2	9.0
	DF20A-30DS-1C	686-0022-9	30	17.2	14.0
Γ	DF20A-40DS-1C	686-0023-1	40	22.2	19.0
	DF20A-50DS-1C	686-0024-4	50	27.2	24.0

[Specifications number]-\*, (\*\*) (59): Gold plating, embossed tape packaging

Note: Sales quantities are by the package unit (containing 100 pieces). Please order by package unit.

# Socket Crimp Contacts

Product No.	CL No.	Type of contacts	Quantity	Plating type
DF20F-2830SCFA(**)	686-0042-6-**	Decl.contecto	Saa anasificationa number column	Cold plating
DF20F-3032SCFA(**)	686-0043-9-**	Reel contacts	See specifications number column	Gold plating

[Specifications number] -\*, (\*\*) Blank 1 reel : 10,000 pieces 41 1 reel : 20,000 pieces

#### •Applicable Wire (Tin plated solid soft conductor)

Applicable Wire Size (Stranded wire conductor)	Jacket diameter
AWG #28 (7/0.127 mm)	
AWG #30 (7/0.1 mm)	0.5mm to 0.6 mm
AWG #32 (7/0.08 mm)	

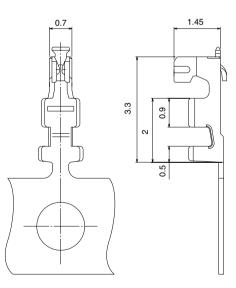
# •Recommended wire UL1571 •Strip length 1.2 to 1.9 mm

Note: When using other than the recommended wire, contact your nearest Hirose representative.

#### •Applicable Crimping Tools

Туре	CL No.	Product No.
Applicator	901-4572-6	AP105-DF20-2830S
Press	901-0005-4	CM-105

Note 1: Hirose Electric will not be responsible for any problems caused by use of tools other than specified.

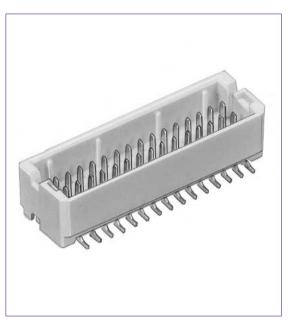


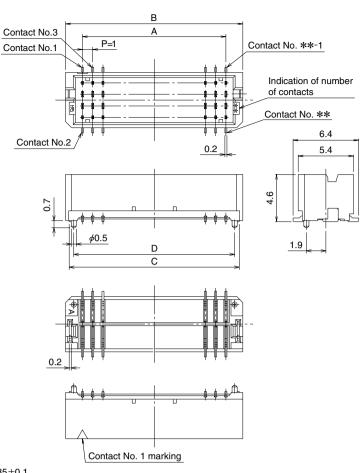
# ■Replacement Parts List for Applicator

Туре	Product No.	CL No.
Insulation crimper	AP105-DF20-2830S(61)	901-4572-6-61
Wire crimper	AP105-DF20-2830S(62)	901-4572-6-62
Insulation anvil and wire anvil	AP105-DF20-2830S(63)	901-4572-6-63



# Double Row Straight Pin header





# ▶ PCB Footprints A±0.05 0.9±0.05 0.85±0.1 0.6±0.05 0.05±0.1

Note 1:Shaded area must be free of any electrically conductive traces to avoid contact with soldered pin header terminations. Note 2: Required only for pin headers supplied with the positioning boss.

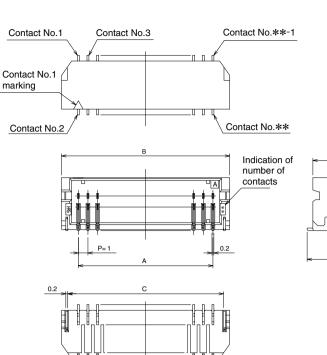
						_	Unit: min
Product No.	CL No.	Number of contacts	А	В	С	D	Remarks
DF20F-10DP-1V(**)	CL686-0032-2- * *	10	4.0	7.3	6.6		
DF20F-20DP-1V(**)	CL686-0033-5-**	20	9.0	12.3	11.6		
DF20F-30DP-1V (**)	CL686-0034-8-**	30	14.0	17.3	16.6	_	Without boss
DF20F-40DP-1V(**)	CL686-0035-0-**	40	19.0	22.3	21.6		
DF20F-50DP-1V ( * * )	CL686-0036-3-**	50	24.0	27.3	26.6	_	
DF20G-10DP-1V(**)	CL686-0037-6-**	10	4.0	7.3	6.6	5.7	
DF20G-20DP-1V(**)	CL686-0038-9-**	20	9.0	12.3	11.6	10.7	
DF20G-30DP-1V(**)	CL686-0039-1-**	30	14.0	17.3	16.6	15.7	With boss
DF20G-40DP-1V(**)	CL686-0040-0-**	40	19.0	22.3	21.6	20.7	
DF20G-50DP-1V(**)	CL686-0041-3-**	50	24.0	27.3	26.6	25.7	
Note1: Order embossed ta	ape packaging items by	the reel. (1 reel conta	ains 1.000	pieces)		[Specificati	ons numberl-*. (**)

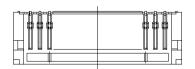
Note1: Order embossed tape packaging items by the reel. (1 reel contains 1,000 pieces) Note2: Vacuum pick-up platforms are included with embossed tape packaged connectors. [Specifications number]-\*, (\*\*) (59): Gold plating, embossed tape packaging



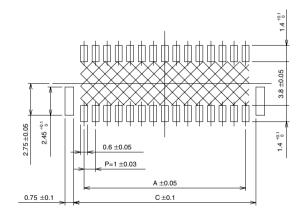
# Double Row Right angle Pin header







# **PCB** Footprints



Note : Shaded area must be free of any electrically conductive traces to avoid contact with soldered pin header terminations.

						Unit: mm
Product No.	HRS No.	Number of contacts	А	В	С	Remarks
DF20F -10DP-1H ( * * )	686-0027-2 ( * * )	10	4.0	7.5	6.2	
DF20F -20DP-1H ( * * )	686-0028-5 (**)	20	9.0	12.5	11.2	
DF20F -30DP-1H (**)	686-0029-8 ( * * )	30	14.0	17.5	16.2	Without boss
DF20F -40DP-1H ( * * )	Reserved for product expansion	40	19.0	22.5	21.2	
DF20F -50DP-1H ( * * )	Reserved for product expansion	50	24.0	27.5	26.2	

[Specifications number]-\*, (\*\*) (59): Gold plating, embossed tape packaging

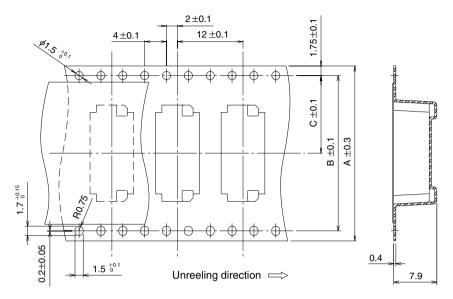
Note:Order embossed tape packaging items by the reel. (1 reel contains 1,000 pieces)

5.5

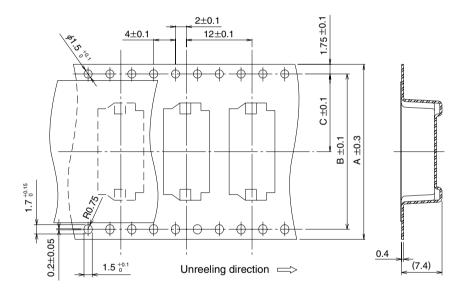
6.2

# Embossed Carrier Tape Dimensions

#### •Straight pin header



#### Right angle pin header



#### Reel dimensions

	Product No.	Number of Contacts	А	В	С	D
	DF20F(G)-10DP-1V	10	16		7.5	16.4
	DF20F(G)-20DP-1V	20	24		11.5	24.4
	DF20F(G)-30DP-1V	30	32	28.4	14.2	32.4
	DF20F(G)-40DP-1V	40	44	40.4	20.2	44.4
	DF20F(G)-50DP-1V	50	44	40.4	20.2	44.4
	DF20F-10DP-1H	10	16		7.5	16.4
	DF20F-20DP-1H	20	24		11.5	24.4
	DF20F-30DP-1H	30	32	28.4	14.2	32.4
*	DF20F-40DP-1H	40	44	40.4	20.2	44.4
*	DF20F-50DP-1H	50	44	40.4	20.2	44.4

Product name label  $\phi$ 1.5 mm diameter feed hole depth  $\phi$ 21±0.8  $2\pm0.5$   $D^{+2}_{0}$ 

\* Reserved for product expansion

# ● Usage recommendation

1. Recommended Soldering					
Temperature Profile for IR Reflow.	Temperature	IR Reflow			
	250°C	Preheating: 150°C for 60 sec. to 120 sec. Soldering: 235°C±5°C for 10 sec. max. Maximum 240°C 220°C min. 10s to 30s 220°C	Maximum 240°C 220°C		
	200°C				
	150℃ —				
	100°C —	Preheating	Soldering		
	50°C _				
	0°C				
	08	Sec 50Sec 100Sec	150Sec 200Sec Time		
	•		sible under the same conditions, provided		
	Note 2: The ter	-	re between the first and second cycle. face temperature at the points of contacts		
2.Recommended Manual Soldering Conditions	Soldering ten	nperature: 290°C ±10°C, Solderir	ng time: within 3 sec.		
3. Recommended Solder Screen Thickness	0.15mm				
4. Board Warping	Maximum of 0.03	mm at the connector center section, with	h both ends of the connector as reference points.		
5. Cleaning Conditions	Refer to "Nylo	n Connector Use Handbook."			
6. Wiring Termination Conditions	Crimp contacts	n Connector Use Handbook." s should be handled with care as i erformance or termination.	not to cause any deformation or damage		
7. Mating / un-mating precautions	Excessive twisting and pulling on wires during mating/un-mating should be avoided as it may cause damage to connectors.				

